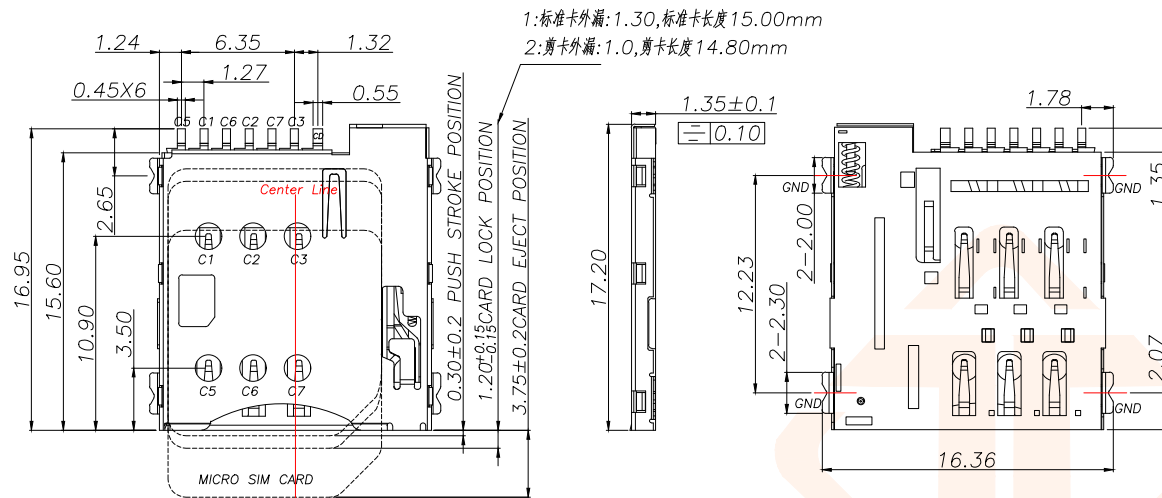




MATERIAL:

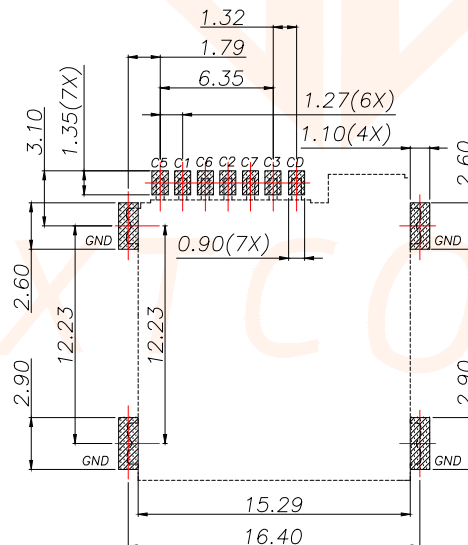
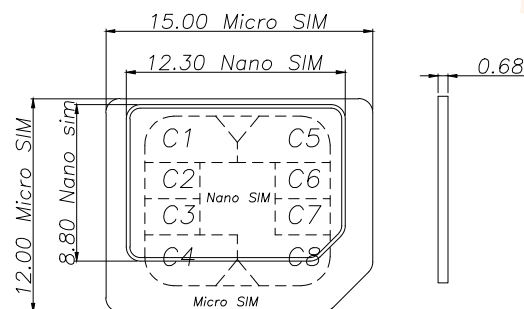
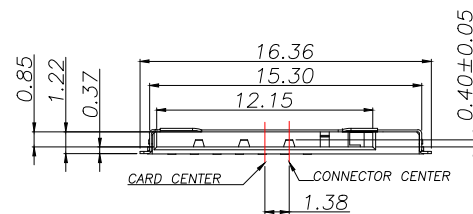
INSULATOR: HIGH TEMPERATURE THERMOPLASTIC, UL 94V-0
CONTACT: COPPER ALLOY
SHELL: SUS

PLATING:

CONTACT: PLATED 50U" NI OVER ALL CONTACT AU 1U
SHELL: PLATED 50U" NI OVERALL
PLATED 1U" AU SELECTIVE CONTACT AREA

ELECTRICAL:

CURRENT RATING: 0.5AMPS MAX
VOLTAGE RATING: 5V AC/DC
AMBIENT TEMPERATURE RANGE: -40℃ ~ +85℃
STORAGE TEMPERATURE RANGE: -40℃ ~ +85℃
AMBIENT HUMIDITY RANGE: 95% R.H. MAX.
CONTACT RESISTANCE: 100MΩ MAX.
INSULATION RESISTANCE: 1000MΩ MIN./500VDC
REFLOW PEAK TEMP: 260℃
MATING CYCLES: 5000MIN INSERTIONS

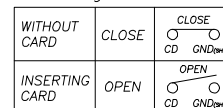


PAD AREA

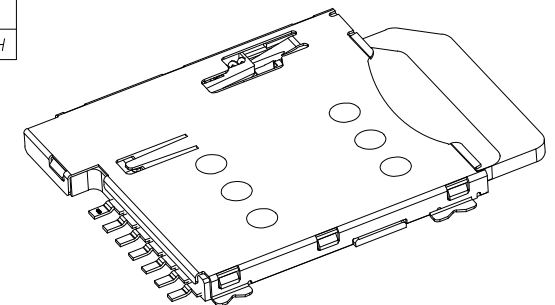
KEEP OUT AREA

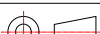
RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05

Circuit Diagram for Detect Switch



MICRO SIM CARD	
Pin No.	NAME
C1	VCC OF SIM
C2	RST OF SIM
C3	CLK OF SIM
C5	GND OF SIM
C6	VPP OF SIM
C7	I/O OF SIM
C4/C8	N/A
CD	DETECTION SWITCH



TOLERANCE		 深圳聚兴泰电子科技有限公司 Shenzhen Juxingtai Electronic Technology Co., Ltd			
.X±0.15		PART NO.	TITLE: MICRO SIM CARD PUSH PUSH 6+1PIN H1.35		
.XX±0.10		MICRO SIM 7P 1.35H PUSH			
.XXX±0.05		DESIGN: Ethan	MANUFACTURE DWG		
UNITS	mm	CHED: Olivia			
MATERILA	— — —	APPD: Ava		SCALE	SHEET
FINISH	— — —			N:A	1/2

